

STS5DNF20V

N-channel 20V - 0.030Ω - 5A SO-8 2.7V - drive STripFETTM II Power MOSFET

General features

Туре	V _{DSS}	R _{DS(on)}	I _D
STS5DNF20V	20V	<0.040Ω (@) 4.5) <0.045Ω (@) 2.7)	5A

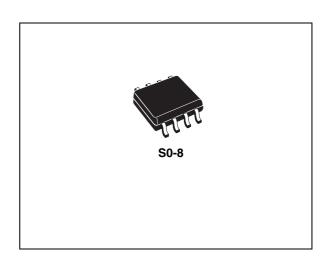
- Ultra low threshold gate drive (2.7 V)
- Standard outline for easy automated surface mount assembly

Description

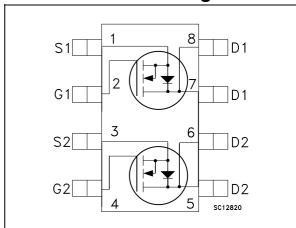
This Power MOSFET is the latest development of STMicroelectronis unique "Single Feature SizeTM" strip-based process. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STS5DNF20V	S5DNF20V	SO-8	Tape & reel

Contents STS5DNF20V

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STS5DNF20V Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (v _{gs} = 0)	20	V
V _{GS}	Gate- source voltage	±12	V
I _D	Drain current (continuos) at T _C = 25°C	5	Α
I _D	Drain current (continuos) at T _C = 100°C	3	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	20	Α
P _{TOT}	Total dissipation at T _C = 25°C dual operation	1.6	W
P _{TOT}	Total dissipation at T _C = 25°C single operation	2	

^{1.} Pulse width limited by safe operating area

Table 2. Thermal data

R _{thj-a}	Thermal resistance junction-ambient single operation Thermal resistance junction-ambient dual operation	62.5 78	°C/W
TJ	Max. operating junction temperature	-55 to 150	°C
T _{stg}	Storage temperature	-55 to 150	°C

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Electrical characteristics STS5DNF20V

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	20			V
I _{DSS}	Zero gate voltage Drain current (V _{GS} = 0)	V_{DS} = Max rating V_{DS} =Max rating, T_{C} =125°C			1 10	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 12V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6			V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 4.5V, I_D = 2.5A$ $V_{GS} = 2.7V, I_D = 2.5A$		0.030 0.037	0.040 0.045	Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 15V, I _D =2.5 A		10		S
C _{iss}	Input capacitance			460		pF
C_{oss}	Output capacitance	$V_{DS} = 25V, f = 1 \text{ MHz},$		200		pF
C_{rss}	Reverse transfer capacitance	V _{GS} = 0		50		pF
Qg	Total gate charge	$V_{DD} = 16V, I_D = 5A,$		8.5	11.5	nC
Q_{gs}	Gate-source charge	$V_{DD} = 16V, I_D = 5A,$ $V_{GS} = 4.5V$		1.8		nC
Q_{gd}	Gate-drain charge	(see Figure 13)		2.4		nC

^{1.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5.

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Rise time	V_{DD} =10 V, I_{D} =2.5A, R_{G} =4.7 Ω , V_{GS} =4.5V (see Figure 12)		7 33		ns ns
t _{d(off)}	Turn-off Delay Time Fall Time	$\begin{aligned} &V_{DD} = 10 \text{ V, } I_D = 2.5\text{A} \\ &R_G = 4.7\Omega, V_{GS} = 4.5\text{V} \\ &(\text{see Figure 12}) \end{aligned}$		27 10		ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current				5	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				20	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 5A, V_{GS} = 0$			1.2	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 5A, V_{DD} = 10V$ di/dt = 100A/ μ s, $T_j = 150$ °C (see Figure 14)		26 13 1		ns nC A

^{1.} Pulse width limited by safe operating area.

^{2.} Pulsed: Pulse duration = 300 μs , duty cycle 1.5 %

Electrical characteristics STS5DNF20V

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

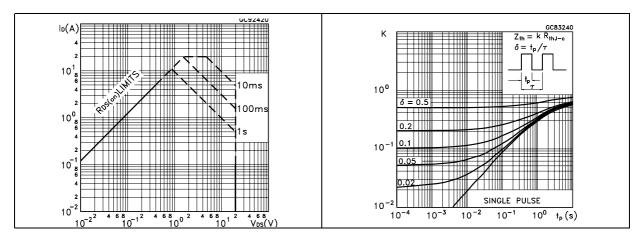


Figure 3. Output characterisics

Figure 4. Transfer characteristics

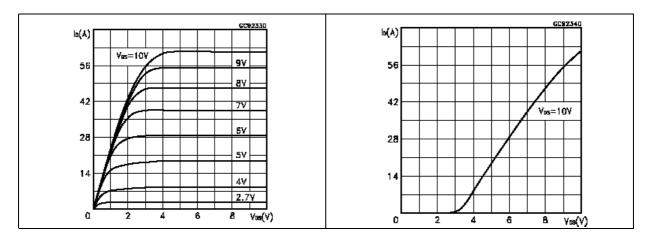
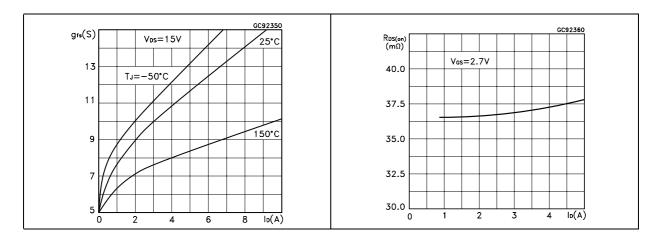


Figure 5. Transconductance

Figure 6. Static drain-source on resistance



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Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

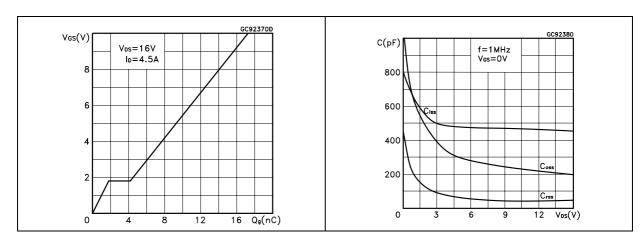


Figure 9. Normalized gate threshold voltage Figure 10. Normalized on resistance vs vs temperature temperature

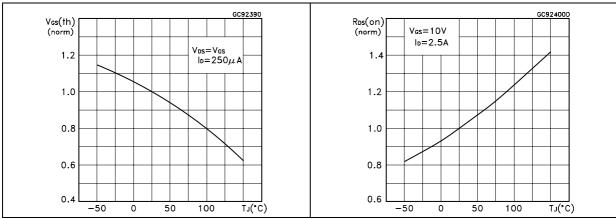
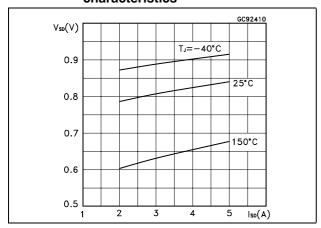


Figure 11. Source-drain diode forward characteristics



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Test circuit STS5DNF20V

3 Test circuit

Figure 12. Switching times test circuit for resistive load

Figure 13. Gate charge test circuit

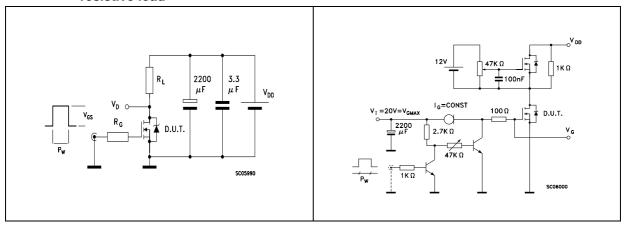


Figure 14. Test circuit for inductive load switching and diode recovery times

Figure 15. Unclamped Inductive load test circuit

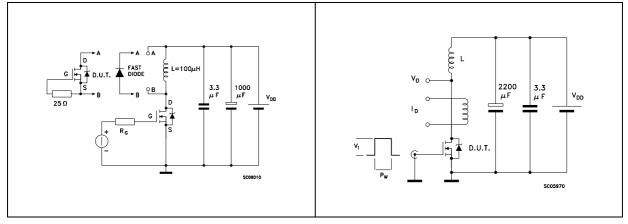
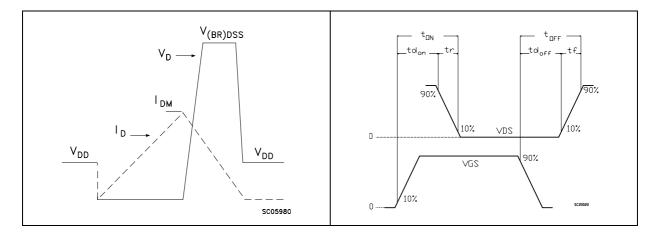


Figure 16. Unclamped inductive waveform

Figure 17. Switching time waveform



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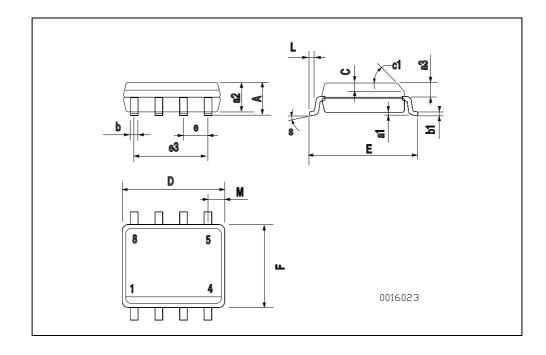
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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SO-8 MECHANICAL [DΑ	۱ΤΑ	١
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DIM.		mm.			inch	
DIIVI.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α			1.75			0.068
a1	0.1		0.25	0.003		0.009
a2			1.65			0.064
a3	0.65		0.85	0.025		0.033
b	0.35		0.48	0.013		0.018
b1	0.19		0.25	0.007		0.010
С	0.25		0.5	0.010		0.019
c1			45	(typ.)		
D	4.8		5.0	0.188		0.196
E	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		3.81			0.150	
F	3.8		4.0	0.14		0.157
L	0.4		1.27	0.015		0.050
М			0.6			0.023
S		•	8 (1	nax.)	•	•



STS5DNF20V Revision history

5 Revision history

Table 7. Revision history

Date	Revision	Changes
21-Jun-2004	4	Complete document
13-Nov-2006	5	The document has been reformatted

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